

### Type 3521 Series

**Key Features** 

2 Watts at 70°C

Small size to power ratio

Supplied on tape

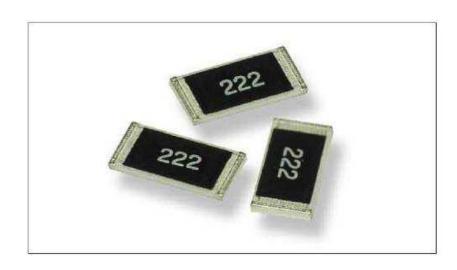
Value marked on resistor

500 volt maximum overload

250 volt maximum working voltage

Terminal finish matte Sn over Ni

AEC-Q200 Qualified

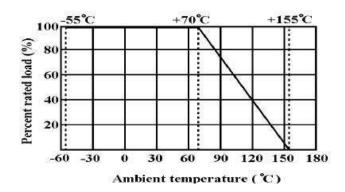


TE Connectivity is pleased to announce that our 3521 series high power Thick Film Chip Resistor is now AEC-Q200 Qualified. This low cost device, suitable for auto placement in volume, and for most applications, including high frequency operations, owing to the short lead structure, is attractively priced and available on 7" reels of 4000 pieces.

#### **Characteristics – Electrical**

| Power Rating                    | 2W             |
|---------------------------------|----------------|
| Resistance Range                | 0.1Ω ~ 10ΜΩ    |
| Tolerance                       | ±1% ±5%        |
| Max. Working Voltage            | 250V           |
| Max. Overload Voltage           | 500V           |
| Dielectric Withstanding Voltage | 500V           |
| Temperature Range               | -55°C ~ +155°C |
| Ambient Temperature             | 70°C           |

Resistors shall have a power rating based on continuous load operation at an ambient temperature of 70  $^{\circ}\text{C}$  . For temperature in excess of 70  $^{\circ}\text{C}$  , The load shall be derated as shown below:





## **Voltage Rating:**

Resistors shall have a rated direct-current (DC) continuous working voltage or an approximate sine-wave root-mean-square (RMS) alternating-current (AC) continuous working voltage at commercial line frequency and waveform corresponding to the power rating , as determined from the following formula:

$$RCWV = VP \times R$$

Where:

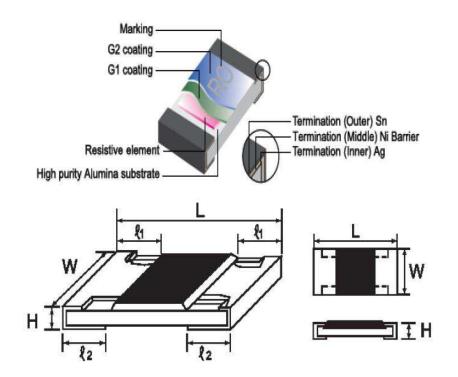
RCWV = Rated DC or RMS AC continuous working voltage at commercial-line frequency and waveform (volt)

P = Power Rating (watt)

R = Nominal Resistance (ohm)

In no case shall the rated DC or RMS AC continuous working voltage be greater than the applicable maximum value.

## **Construction & Dimensions:**

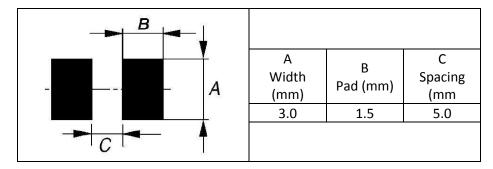


Dimensions: (mm)

| L         | L W       |           | £1        | €2        |  |
|-----------|-----------|-----------|-----------|-----------|--|
| 6.35±0.10 | 3.20±0.20 | 0.55±0.10 | 0.60±0.25 | 0.50±0.20 |  |



## **Recommended solder pad**



- 4 layers PCB specification:
- 1) Outside 2 layers (Top and Bottom) with copper foil thickness at 2oz.
- 2) Inside 2 layers (Middle layers) with copper foil thickness at 4 oz.

## Marking:

For E24 series Values three digit marking, the first two digits are significant figures and the third denoting number of zeros.

E.G. 333

For Ohmic Values below  $10\Omega$ 

E.G. 3.3Ω

For E96 Values four digit marking, the first three showing significant figures and the fourth showing number of zeros. As previously letter R is for decimal point.

E.G. 49K9Ω



# **Performance Specification:**

| Characteristics     | Limits   | Test Methods   |  |  |  |
|---------------------|--|--|--|--|--|
|                     |  | 125°C, at 35% of operating power, 1000H  |  |  |  |
| Operational life    | ±(1%+0.1Ω)max  | (1.5 hours "ON", 0.5 hour "OFF").  |  |  |  |
| Operational life    |  | (MIL-STD-202)  |  |  |  |
|                     | <100mΩ   | Apply to rate current for $0\Omega$  |  |  |  |
|                     | 0.1Ω <r<0.976ω td="" ±100ppm<=""><td>Parametrically test per lot and sample size</td></r<0.976ω> | Parametrically test per lot and sample size  |  |  |  |
| Electrical          | $1\Omega \le R \le 10\Omega \le \pm 400 PPM/^{\circ}C$   | requirements, summary to show Min, Max,  |  |  |  |
| Characterisation    | 10Ω < R ≦100Ω ≤ ±200PPM/°C   | Mean and Standard deviation at room as   |  |  |  |
|                     | 100Ω <r≦10mω td="" °c<="" ±100ppm="" ≤=""><td>well as Min and Max operating</td></r≦10mω>        | well as Min and Max operating  |  |  |  |
|                     | -  | temperatures. (User Spec)  |  |  |  |
| Futamal Marral      | No Manhanian Damana  | Electrical test not required. Inspect device   |  |  |  |
| External Visual     | No Mechanical Damage   | construction, marking and workmanship (MIL-STD-883 Method 2009)  |  |  |  |
|                     |  | Verify physical dimensions to the applicable   |  |  |  |
|                     |  | device detail specification.   |  |  |  |
| Physical            | Reference 2.0 Dimension  | Note: User(s) and Suppliers spec. Electrical   |  |  |  |
| Dimension           | Standards  | test not required.   |  |  |  |
|                     |  | (JESD22 MH Method JB-100)  |  |  |  |
|                     |  | Note: Add Aqueous wash chemical – OKEM   |  |  |  |
| Resistance to       | A A and it and the same and  | Clean or equivalent.   |  |  |  |
| Solvent             | Marking Unsmeared  | Do not use banned solvents.  |  |  |  |
|                     |  | ( MIL-STD-202 Method 215)  |  |  |  |
| Torminal Charact    | Not broken   | Force of 1.8kg for 60 seconds.   |  |  |  |
| Terminal Strength   | Not broken   | (JIS-C-6429)   |  |  |  |
|                     |  | 1000hrs. @T=155°C.Unpowered.   |  |  |  |
| High Temperature    | Resistance change rate is  | Measurement at 24±2 hours after test   |  |  |  |
| Exposure            | ± (0.5%+0.1Ω) Max.   | conclusion.  |  |  |  |
| (Storage)           |  | (MIL-STD-202 Method 108)   |  |  |  |
|                     | <50mΩ  | Apply to rate current for 0Ω   |  |  |  |
|                     | Resistance change rate is  | 1000 Cycles (-55°C to +155°C). Measurement   |  |  |  |
| Temperature         | ± (0.5%+0.1Ω) Max.   | at 24±2 hours after test conclusion  |  |  |  |
| cycling             | 450m0  | (JESD22 Method JA-104)   |  |  |  |
|                     | <50mΩ  | Apply to rate current for 0Ω   |  |  |  |
|                     |  |  |  |  |  |
| Moisture            | Resistance change rate is  | 2FC 3540 300 7550 2500 500 7550 500 THE STATE ST |  |  |  |
| Resistance          | ± (0.5%+0.1Ω) Max.   |  |  |  |  |
|                     |  | T=24 hours /cycle. Unpowered.  |  |  |  |
|                     |  | Measurement at 24±2 hours after test   |  |  |  |
|                     |  | conclusion. (MIL-STD-202 Method 106)   |  |  |  |
|                     | <50mΩ  | Apply to rate current for $\Omega\Omega$   |  |  |  |
|                     |  | 10% rated power, 85°C/85%RH, 1000H.  |  |  |  |
|                     | Resistance change rate is  | Measurement at 24 hours after test   |  |  |  |
| Biased Humidity     | ± (1%+0.1Ω) Max  | conclusion.  |  |  |  |
| ,                   | , , , , , , , , , , , , , , , , , , ,  | (MIL-STD-202 Method 103)   |  |  |  |
|                     | <100mΩ   | Apply to rate current for $\Omega$   |  |  |  |
|                     | ±(1%+0.1Ω) max   | Wave Form: Tolerance for half sine shock   |  |  |  |
| Mechanical Shock    |  | pulse. Peak value is 100g's. Normal duration   |  |  |  |
| ivicentalited SHOCK |  | (D) is 6.  |  |  |  |
|                     |  | (MIL-STD-202 Method 213)   |  |  |  |
|                     |  | 5g's for 20 min., 12cycle each of 3  |  |  |  |
|                     |  | orientations.  Note: Use 8"*5"PCB. 031" thick 7 secure   |  |  |  |
|                     |  | points (onone) long side and 2 secure points   |  |  |  |
| Vibration           | ±(1%+0.1Ω) max   | at corners of opposite sides. Parts mounted  |  |  |  |
|                     |  | within 2' from any secure point.   |  |  |  |
|                     |  | Test from 10-2000Hz.   |  |  |  |
|                     |  | (MIL-STD-202 Method 204)   |  |  |  |
|                     |  | (MIL-STD-202 Method 204)   |  |  |  |

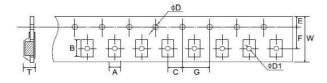


# **Performance Specification (continued)**

| Characteristics       | Limits   | Test Methods                                   |  |  |
|-----------------------|--|--|--|--|
|                       |  | -55°C/+155°C                                   |  |  |
|                       |  | Note: Number of cycles required -300,          |  |  |
| The average Character | ±(1%+0.1Ω) max   | Maximum transfer time -20 seconds, Dwell       |  |  |
| Thermal Shock         |  | time -15 minutes. Air-Air.                     |  |  |
|                       |  | (MIL-STD-202 Method 107)                       |  |  |
|                       | <50mΩ  | Apply to rate current for $0\Omega$            |  |  |
|                       |  | With the electrometer in direct contact with   |  |  |
|                       |  | the discharge tip, verify the voltage setting  |  |  |
|                       |  | at levels of                                   |  |  |
| ESD                   | ±(10%+0.1W)max   | ±500V,±1KV, ±2KV, ±4KV, ±8KV,                  |  |  |
|                       |  | The electrometer reading shall be within       |  |  |
|                       |  | ±10% for voltages from 500V to ≦800V.          |  |  |
|                       |  | (AEC-Q200-002)                                 |  |  |
|                       |  | For both leaded & SMD. Electrical test not     |  |  |
|                       |  | required                                       |  |  |
|                       | 95% coverage Min.  | Magnification 50X. Conditions:                 |  |  |
| Solderability         |  | a) Method B 4hrs at 155°C dry heat, the dip    |  |  |
| Solderability         |  | in bath with 245°C,5s.                         |  |  |
|                       |  | b) Method B: at 215°C,5s.                      |  |  |
|                       |  | c) Method D: at 260°C, 60s.                    |  |  |
|                       |  | ( J-STD-002)                                   |  |  |
|                       | No ignition of the tissue paper or scorching of the pinewood board | V-0 or V-1 are acceptable. Electrical test not |  |  |
| Flammability          |  | required.                                      |  |  |
|                       | scorening of the pinewood board                                    | (UL-94)  |  |  |
| Board Flex            | ±(1%+0.05W)max   | 2mm (Min) (JIS-C-6429)                         |  |  |
| board riex            | <50mW  | Apply to rate current for 0 W                  |  |  |
|                       |  | Temperature sensing at 5002, Voltage           |  |  |
|                       |  | power subjected to 32VDC current clampe        |  |  |
| Flame Retardance      | No flame   | up to 500ADC and decreased in                  |  |  |
|                       |  | 1.0VDC/hour.                                   |  |  |
|                       |  | ( AEC-Q200-001)                                |  |  |
|                       | ±(1%+0.05Ω)max.  | Condition B No per-heat of samples. Note:      |  |  |
|                       |  | Single Wave Solder-Procedure 2 for SMD         |  |  |
| Resistance to         |  | and Procedure 1 for Leaded with solder         |  |  |
| soldering Heat        |  | within 1.5mm of device body.                   |  |  |
|                       |  | (MIL-STD-202 Method 210)                       |  |  |
|                       | <50mW Apply to rate current for 0 W                                |  |  |  |
| * Culturation tast: L | 2S 3~5PPM 50°C±2°C 91%~93%RH :                                     | 1000H  |  |  |

## **Packaging specification**

## **Embossed Taping:**

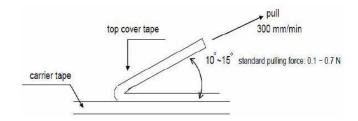


| Α    | В    | С     | ØD+0.1 | ØD1+0.1 | E    | F     | G    | W    | Τ±  |
|------|------|-------|--------|---------|------|-------|------|------|-----|
| ±0.2 | ±0.2 | ±0.05 | -0     | -0      | ±0.1 | ±0.05 | ±0.1 | ±0.2 | 0.1 |
| 3.50 | 6.70 | 2.0   | 1.5    | 1.5     | 1.75 | 5.5   | 4.0  | 12.0 | 1.0 |

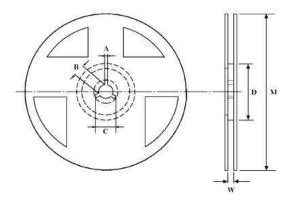


#### **Peeling Strength of Top Cover Tape**

Test Condition: 0.1 to 0.7 N at a peel-off speed of 300 mm / min.



#### **Reel Dimensions**



| T | ape     | Reel  | A ± | В±  | C ± | D ± 1 | M ± 2 | W ± 1 |
|---|---------|-------|-----|-----|-----|-------|-------|-------|
|   |         | Qty   | 0.5 | 0.5 | 0.5 |       |       |       |
| E | mbossed | 4,000 | 2   | 13  | 21  | 60    | 178   | 13.8  |

#### **Environment Related Substance**

This product complies to EU RoHS directive, EU PAHs directive, EU PFOS directive and Halogen free.

## Ozone layer depleting substances.

Ozone depleting substances are not used in our manufacturing process of this product.

This product is not manufactured using Chloro fluorocarbons (CFCs), Hydrochlorofluorocarbons (HCFCs), Hydrobromofluorocarbons (HBFCs) or other ozone depleting substances in any phase of the manufacturing process.



### **Storage Condition**

The performance of these products, including the solderability, is guaranteed for a year from the date of arrival at your company, provided that they remain packed as they were when delivered and stored at a temperature of  $25^{\circ}\text{C} \pm 10^{\circ}\text{C}$  and a relative humidity of  $60\%\text{RH} \pm 10\%\text{RH}$ , chemical and dust free atmosphere

Even within the above guarantee periods, do not store these products in the following conditions, otherwise their electrical performance and/or solderability may be deteriorated, and the packaging materials (e.g. taping materials) may be deformed or deteriorated, resulting in mounting failures.

- 1. In salty air or in air with a high concentration of corrosive gas, such as Cl2, H2S, NH3, SO2, or NO2
- 2. In direct sunlight

#### AEC-Q200

The 3521 series is qualified to AEC-Q200 standard at Grade"4"

#### **How To Order**

| 3521                         | 10K  | F         |               |
|------------------------------|--|-----------|---------------|
| <b>Common Part</b>           | Resistance Value   | Tolerance | Pack Style    |
| 3521 – SMD<br>Power Resistor | 1Ω - 1R0<br>100Ω - 100R<br>1,000Ω (1ΚΩ) -1Κ0<br>10,000Ω (10ΚΩ) - 10Κ<br>1,000,000Ω (1ΜΩ) - 1Μ0 | F – 1%    | T – 4000 Reel |

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